

Electronic Patent Application Fee Transmittal

Application Number:	10549440			
Filing Date:	16-Sep-2005			
Title of Invention:	Copper alloy sputtering target process for producing the same and semiconductor element wiring			
First Named Inventor/Applicant Name:	Takeo Okabe			
Filer:	William Bak			
Attorney Docket Number:	OGOSH39USA			
Filed as Large Entity				
U.S. National Stage under 35 USC 371 Filing Fees				
Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Basic Filing:				
Pages:				
Claims:				
Miscellaneous-Filing:				
Petition:				
Patent-Appeals-and-Interference:				
Post-Allowance-and-Post-Issuance:				
Extension-of-Time:				

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Miscellaneous:				
Request for continued examination	1801	1	810	810
Total in USD (\$)				810